

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
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Property Type	Number
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Total Attachments: 1 source=12112-59 assign1#page1.tif	

**CH \$40.00 12739175**

PCT08029 US  
12112-59

Docket No.:

**ASSIGNMENT**

This is an Assignment of the following rights, title and interest:

United States of America rights, title and interest in the invention

United States Patent Application Serial No. \_\_\_\_\_

Date of Execution: \_\_\_\_\_

Date of Filing: \_\_\_\_\_

Title of the Invention:

Composite Metal Material and Method for Producing the Same

Inventor (assignor):

Bunshi FUGETSU

Assignee:

NATIONAL UNIVERSITY CORPORATION HOKKAIDO UNIVERSITY,  
8, Kita 8-jyo Nishi 5-chome, Kita-ku, Sapporo-shi, Hokkaido 060-0808 Japan

Whereas, I, the above-identified Inventor, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas I desire to assign my above-identified rights, title and interest in the Invention to the above-identified assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

I hereby assign, sell and transfer my above-identified rights, title and interest in said Invention, said applications(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States, unto said Assignee.

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And I further agree to sign and execute all necessary and lawful future documents, including applications, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

*Bunshi Fugetsu*

Signature: Bunshi FUGETSU

*2010 Feb. 25*

Date